

WARNING

The following servicing instructions are for use by qualified personnel only. To avoid personal injury, do not perform any servicing unless you are qualified to do so. Refer to the Safety Summary prior to performing any service.

Please check for CHANGE INFORMATION at the rear of this manual.



Instrument Serial Numbers

Each instrument manufactured by Tektronix has a serial number on a panel insert or tag, or stamped on the chassis. The first letter in the serial number designates the country of manufacture. The last five digits of the serial number are assigned sequentially and are unique to each instrument. Those manufactured in the United States have six unique digits. The country of manufacture is identified as follows:

| B010000 | Tektronix, Inc., Beaverton, Oregon, USA |
|---------|--|
| G100000 | Tektronix Guernsey, Ltd., Channel Islands |
| E200000 | Tektronix United Kingdom, Ltd., London |
| J300000 | Sony/Tektronix, Japan |
| H700000 | Tektronix Holland, NV, Heerenveen, The Netherlands |

Instruments manufactured for Tektronix by external vendors outside the United States are assigned a two digit alpha code to identify the country of manufacture (e.g., JP for Japan, HK for Hong Kong, etc.).

Tektronix, Inc., P.O. Box 500, Beaverton, OR 97077

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General Information

This section gives all the information needed to apply power to the SD-24 TDR/Sampling Head.

Safety information as well as information on installing and removing the sampling head, packaging for shipment, and environmental conditions such as operating temperature is included here.

Introduction

The SD-24 TDR/Sampling Head Service Reference manual is designed for use by qualified service personnel. It contains information necessary to check and maintain the SD-24 TDR/Sampling Head.

The SD-24 TDR/Sampling Head is a two-channel, 17.5 ps rise time sampling head. Each channel is also capable of generating its own TDR output pulse. The SD-24 TDR/Sampling Head is designed for use in 11800-Series Digital Sampling Oscilloscopes and in the SM-11 Multi-Channel Unit

SD-24 Service Reference 1-1

Safety Summary

The safety information in this part of the summary is for both operating and servicing personnel. Specific warnings and cautions will be found throughout the manual where they apply, but may not appear in this summary.

Terms in Manuals

CAUTION statements in manuals identify conditions or practices that could result in damage to the equipment or other property.

WARNING statements in manuals identify conditions or practices that could result in personal injury or loss of life.

Terms on Equipment

CAUTION on equipment means a personal injury hazard not immediately accessible as one reads the marking, or a hazard to property including the equipment itself.

DANGER on equipment means a personal injury hazard immediately accessible as one reads the marking.

Symbols in Manuals



Static Sensitive Devices

Symbols on Equipment



DANGER High Voltage



Protective ground (earth) terminal



ATTENTION Refer to manual

Grounding the Instrument

This sampling head is grounded through the grounding conductor of the oscilloscope's power cord. To avoid electric shock, plug the power cord into a properly wired receptacle before connecting to the product input or output terminal. A protective-ground connection, by way of the grounding conductor in the power cord, is essential for safe operation.

Danger Arising from Loss of Ground

Upon loss of the protective-ground connection, all accessible conductive parts (including knobs and controls that may appear to be insulating), can render an electric shock.

Do Not Operate in Explosive Atmospheres

To avoid explosion, do not operate the sampling head in an atmosphere of explosive gasses.

Installing and Removing the Sampling Head

To avoid damage to the oscilloscope, set the oscilloscope's ON/STANDBY switch to STANDBY before installing or removing a sampling head.

The SD-24 TDR/Sampling Head slides into the one of the front panel compartments of the 11801 or 11802 Digital Sampling Oscilloscopes. Figure 1-1 shows the front panel of an oscilloscope and the locations of the sampling head compartments.

With the ON/STANDBY switch set to STANDBY, place the sampling head in a compartment and slowly push it in with firm pressure. Once the sampling head is seated, turn the lock-down screw to tighten the sampling head in place.



Never install or remove a sampling head when the ON/STANDBY switch is ON.

If the green indicator light remains on when the STANDBY position is selected, then the switch has been left internally disabled after the servicing of the power supply. To enable the ON/STANDBY switch, refer to the Maintenance section of the 11801 or 11802 Digital Sampling Oscilloscope Service Reference manual.

To remove the sampling head from an oscilloscope, set the oscilloscope's ON/STANDBY to STANDBY. Turn the lock-down screw to loosen the sampling head, and then slowly pull out the sampling head.

SD-24 Service Reference 1-3

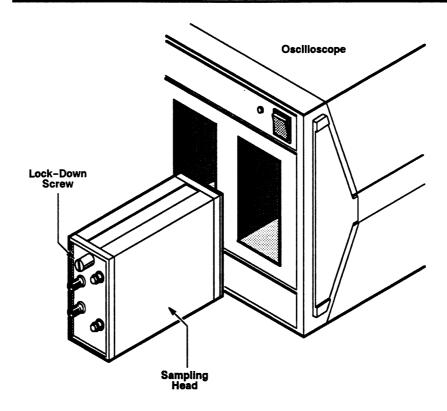


Figure 1-1 - Installing a Sampling Head In An Oscilloscope

Packaging for Shipment

If possible, save and reuse the original carton and packaging to package sampling head when shipping it by commercial transportation. Attach short circuit terminations to the sampling inputs.

Attach a tag to the sampling head if it is shipped to your local Tektronix Service Center for service or repair. Include the following information on the tag:

- Name and address of the oscilloscope and sampling head owner;
- Name of a person at your firm who can be contacted about the oscilloscope and sampling head;
- Complete oscilloscope and sampling head type and serial number; and
- A description of the service required.

Package the sampling head as follows, if the original package is not available or is not fit for use:

| | ·· |
|-----------|---|
| Step 1: | Attach short circuit terminations to the sampling head inputs. |
| least six | Obtain a corrugated cardboard carton with inside dimensions at inches (15 cm) greater than the sampling head dimensions. Use a ith a bursting test strength of at least 200 pounds per square-inch. |
| • | Fully wrap the sampling head with anti-static sheeting, or its nt, to protect the finish. |

1-4 General Information

| Ш | sampling | Tightly pack dunnage or urethane foam between the carton and the phase inches the carton the sampling head on all sides. Allow three inches ing on each side. |
|---|----------|---|
| | Step 5: | Seal the carton with shipping tape or with industrial staples. |
| | | Mark the address of the Tektronix Service Center and your return on the carton in one or more prominent places. |

Operating Environment

The following environmental requirements are provided to ensure proper operation and long sampling head life.

Operating Temperature

Operate the sampling head where the ambient air temperature is between 0° and $+50^{\circ}$ C. Store the sampling head in ambient temperatures from -40° to $+75^{\circ}$ C. After storage at temperatures outside the operating limits, allow the chassis to reach the operating temperature range before applying power.

Enhanced Accuracy of the oscilloscope is available after a 20-minute warmup period. After entry into Enhanced Accuracy, the oscilloscope reverts to non-enhanced accuracy if the internal oscilloscope temperature changes more than 5°C.

SD-24 Service Reference

Checks and Adjustments

This section contains procedures to check the specifications and measurement limits listed in Table 2-1. The Specification or Measurement Limit is listed at the beginning of each part as well. These procedures contain only check steps, since the SD-24 TDR/Sampling Head has no internal adjustments. The parts in this section provide a logical sequence of checks for performing a comprehensive performance verification procedure to verify that the sampling head meets specifications. To functionally test the sampling head, perform the parts in Table 2-1 which have a "yes" indication in the Functional Test Column.

Refer to the SD-24 TDR/Sampling Head Installation/User Reference manual for more information about specifications and sampling head operation. Refer to Table 2-2 for information concerning test equipment used in the setups.

Table 2-1 — Measurement Limits and Specifications

| Part and Description | Measurement Limit | Specification | Functional Test |
|-------------------------------------|--------------------------|-------------------------|--------------------|
| Part 1 Power-On | none | none | yes |
| Part 2 Dot Transient Response | | | |
| 250 mV with automatic calibration | ≤5% error | | yes |
| 500 mV with automatic calibration | ≤5% error | | no |
| 500 mV with default settings | ±20% error | | no |
| 1.0 V without automatic calibration | | adjusted to 100% at 1 V | no |
| Part 3 Offset | | | |
| Offset | ±2 mV | | yes |
| Offset change with repetition rate | | ±5 mV | no |
| Part 4 Noise (SN B020652 and | above) | | no |
| Smoothing, on Smoothing, off | ≤550 μV ms ≤1.2 mV ms | | |
| Part 4 Noise (SN B010651 and below) | | | no |
| Smoothing, on Smoothing, off | ≤900 μV rms ≤2 mV rms | | |
| Part 5 Rise Time | | 17.5 ps | yes |

Table 2-1 — Measurement Limits and Specifications (cont)

| Part and Description | Measurement Limit | Specification | Functional Test |
|--|--|-----------------|--------------------|
| Part 6 Acquisition Aberrations (with 067-1338-00 source) | | | no |
| 0 to 300 ps 300 ps to 5 ns 5 ns to 100 ns 100 ns and up -10 ns to -20 ps | -7% to 12% ±4% ±1.2% ±0.6% ±4% | | |
| Part 7 Coincidence Between Channels | | 10 ps | no |
| Part 8 Maximum Signal Voltage | 1% of step amplitude | | no |
| Part 9 Isolation Between Channels | | 1% | no |
| Part 10 Output Amplitude | | 250 mV ±5 mV | yes |
| Part 11 TDR Aberrations | | | no |
| 0 to 300 ps | -5% to 15% | | |
| 300 ps to 5 ns 5 ns and up | | ±3% ±1% | |
| -10 ns to -20 ps | | ±1% ±3% | |
| Part 12 Reflected Rise Time | | 35 ps | no |

Test Equipment

The test equipment in Table 2-2 contains suggested test equipment for use in this manual. Procedure steps are based on the test equipment examples given, but other equipment with similar specifications may be substituted. Test results, setup information, and related connectors and adapters may be altered by the use of different equipment.

Table 2-2 — Test Equipment

| Description | Minimum Specification | Examples of Applicable Test Equipment |
|--|---|---|
| 11800-Series Oscillo- scope | Tektronix digital sampling oscilloscope | TEKTRONIX 11801 Digital Sampling Oscilloscope TEKTRONIX 11802 Digital Sampling Oscilloscope |
| Pulse Generator | 1 ns rise time, 5 V output, 10 Hz to 250 MHz frequency range | TEKTRONIX PG 502 Pulse Generator with a TM 500-Series Power Module |
| Time Mark Generator | 1 ns through 5 s markers in a 1-2-5 sequence, at least 5 parts in 10 ⁷ accuracy | TEKTRONIX TG 501 Time Mark Generator with a TM 500-Series Power Module |
| Calibration Generator | DC output, 0.5% accuracy 1 V output amplitude | TEKTRONIX PG 506 Calibration Generator with a TM 500-Series Power Module |
| Calibration Step Generator | | TEKTRONIX 067-1338-0X Calibration Step Generator (where X represents either a 0, 1, 2, 3, 5, or 6; depending on the power supply appropriate for your country. Refer to Section 5, Replaceable Parts) |
| System Controller | Any compatible control- ler with MS DOS and a serial port configured for COM1 | TEKTRONIX PEP 301 System Controller |
| 50 Ω Termination, SMA connectors | Impedance 50 Ω , SMA connectors | Tektronix Part 015-1022-00 |
| 50 Ω Termination, BNC connectors | Impedance, 50Ω , BNC connectors | Tektronix Part 011-0049-01 |
| Precision Short Circuit Termination | Female 3.5 mm compatible connectors | Tektronix Part 011-0150-00 |
| Precision 6-inch Semi- Rigid Cable | Male to male 3.5 mm compatible connectors | Tektronix Part 015-0564-00 |

Table 2-2 — Test Equipment (cont)

| Description | Minimum Specification | Examples of Applicable Test Equipment |
|--|--|--|
| Short Circuit Terminators, SMA Connections (2 required) | Male SMA Connectors | Tektronix Part 015-1020-00 |
| Coaxial Cable, 50 Ω (2 required) | 50 Ω , 36-inch, male BNC connectors | Tektronix Part 012-0482-00 |
| Serial Cable | 10-ft RS-232-C Cable | Tektronix Part 012-0911-00 |
| Adapter, SMA to BNC (2 required) | SMA male to BNC female | Tektronix Part 015-0554-00 |
| Attenuator, 2X | 6 dB attenuation, 50 Ω , one male and one female BNC | Tektronix Part 011-0069-02 |
| Attenuator, 5X | 14 dB attenuation, 50 Ω , one male and one female BNC | Tektronix Part 011-0060-02 |
| Wrist Strap | | Tektronix Part 006-3415-00 |
| Static Control Mat | | Tektronix Part 006-3414-00 |
| Needle-nose pliers | | |
| Pozidrive Screwdriver | P1 tip | |

Using These Procedures

Each part begins with a setup illustration that shows what test equipment is needed and how to connect it. Refer to Table 2-2 for an example of the test equipment for each part.

Conventions in this Manual

In these procedures, the following conventions are used:

- CAPITAL letters within the body of text identify front panel controls, indicators, and connectors (for example, MEASURE) on the oscilloscope and sampling head.
- Bold letters identify menu labels and display messages.
- Initial Capital letters identify connectors, controls, and indicators (for example, Position) on associated test equipment. Initial Capital letters also identify adjustments inside the sampling head.

In some steps, the first word is italicized to identify a step that contains a performance verification and/or an adjustment instruction. For example, if *Check* is the first word in the title of a step, an electrical specification is checked. If *Adjust* appears in the title, the step involves an electrical adjustment. If *Examine* is the first word in the title, the step concerns measurement limits that indicate whether the sampling head is operating properly; these limits are not to be interpreted as electrical specifications.

Initialized and Stored Settings

At the beginning of most steps, the user is instructed to **Initialize** the oscilloscope as part of the setup. The **Initialize** feature, available through the UTILITY menu, presets all oscilloscope controls and functions to known values. Initializing the oscilloscope at the beginning of a step eliminates the possibility of settings from previous parts causing erroneous or confusing results.

Menu Selections and Measurement Techniques

Details on measurement techniques and instructions for making menu selections are generally not included in this manual. Comprehensive descriptions of menus and oscilloscope features are located in the 11801 User Reference manual, the 11802 User Reference manual, and the SD-24 TDR/Sampling Head Installation/User manual.

Tutorial Manual

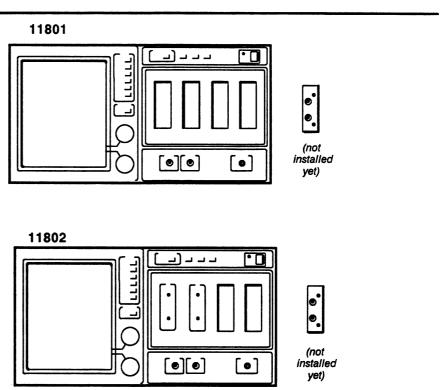
The tutorial manuals, *Introducing the 11801 Digital Sampling Oscilloscope* and *Introducing the11802 Digital Sampling Oscilloscope*, are strongly recommended to familiarize the first-time user with 11801 and 11802 Oscilloscope controls and features.

Part 1 Power-on

2-6

Perform this part within the ambient temperature range of $+18^{\circ}$ and $+28^{\circ}$ C, to assure proper oscilloscope operation.

Setup to Power-on



Setup to Power-on

Procedure to Power-on

| Ш | Step 1: | Set the following in the order listed: |
|---|--------------------|--|
| | Samplin | g head Not installed yet |
| | 11801/1 | 1802 Oscilloscope |
| | ON/ | STANDBY switch STANDBY |
| | Step 2: compart | Install a SD-Series sampling head in the oscilloscope's left-most ment. |
| | - | With the oscilloscope's rear panel PRINCIPAL POWER SWITCH set connect the 11801/11802 Oscilloscope to a suitable power source. |
| | • | Set the rear panel PRINCIPAL POWER SWITCH to ON and then the |

When the 11801/11802 Oscilloscope is first installed, the rear panel PRINCIPAL POWER SWITCH should be set to and remain in the ON position. Then, use the front panel ON/STANDBY switch to perform all subsequent power switching.

- Step 5: Power-on the following test equipment, so that it is warmed up with the oscilloscope to be tested:
 - Calibration generator
 - Calibration step generator
 - Time mark generator
 - Pulse generator

A complete list of test equipment is listed in Table 2-2.

Before doing the performance checks, allow a 20 minute warm-up for the Sampling head and test equipment.

Part 2 **Dot Transient** Response

This part shows the setup and lists the procedures to check the dot transient response. The dot transient response is examined at 250 mV and 500 mV with automatic calibration settings, at 500 mV with default settings, and checked at 1 V with manual calibration settings.

Measurement Limits

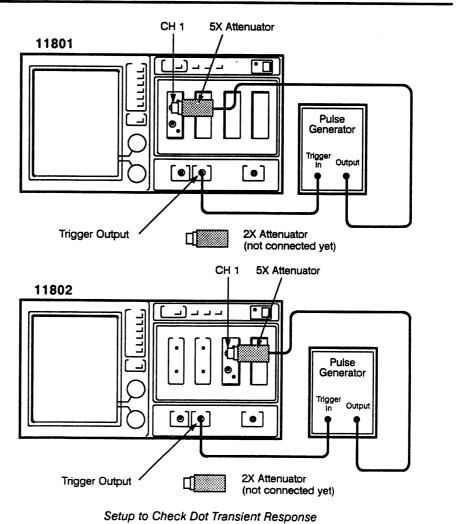
The measurement limits for the dot transient response error are:

- ≤5 % error when measured at 250 mV and 500 mV with automatic calibration settings
- 20% error when measured at 500 mV with default settings

Specifications

The specification for the dot transient response at 1 V is that the amplitude is adjustable to 100%.

Setup to Check Dot Transient Response



| Pro | ocedure to Ch | eck Dot Transient Response |
|-----|---|--|
| | Step 1: Initial in the order lie | alize the oscilloscope settings, then make the following settings sted: |
| | Vert Size TRIGGER Sour Main Pos Main Size Pulse Genera Back Terr Trigger Sc | LECT CHANNEL On/Off On Oscilloscope :: M1 50 mV/division :: button press ce Internal Clock s Min e 20 ns/division |
| | amine Dot Restorming Steps | sponse at 250 mV with Automatic Calibration Settings – by 2 through 30. |
| | Step 2: Set | the pulse generator's amplitude for a 375 mV display. |
| | Step 3: Set on the screen | the Vert Offset: M1 so that the step is approximately centered in. |
| | Step 4: Pres Gain. | ss the ENHANCED ACCURACY button, and then touch Loop |
| | Step 5: Touc Calibration p | ch Automatic Calibrate and then Proceed in the Loop Gain pop-up menu. |
| | Step 6: Touc | ch Exit in the Loop Gain Calibration pop-up menu. |
| | Step 7: Set | the pulse generator's amplitude for a 250 mV step display. |
| | Step 8: Pres | ss the WAVEFORM button, and then touch Horizontal Desc. |
| | • | ch Main Record Length in the Horizontal Description pop-up en set the top knob for a Main Record Length of 512. |
| | Step 10: Pre | ess the UTILITY button and then Instr Options. |
| | Step 11: Se menu. | t Vectored Trace to Off in the Instrument Options pop-up |
| | • | uch Display Intensity in the Instrument Options pop-up menu, the top knob for 90% intensity. |
| | Step 13: To | uch Exit. |
| | Step 14: Too | uch Cursors on the top of the screen. |
| | Step 15: Too pop-up menu | uch Cursor Type and then Horizontal Bars in the Cursor Type |

| Step 16: | Touch Exit. |
|-----------------------------|--|
| Step 17: before the | Set Cursor 1 (top knob) to the average of the bottom of the pulse e step. |
| Step 18: | Set Cursor 2 (bottom knob) to the top of the step. |
| Step 19: value as ' | Read ΔV as the peak-to-peak step amplitude, and then record this V for later use. |
| Step 20: | Press the ENHANCED ACCURACY button. |
| | Touch Loop Gain and then the channel you are using in the Loop ibration pop-up menu. |
| Step 22: pop-up m | Set the Divide by Two Mode to On in the Loop Gain Calibration senu. |
| Step 23: | Touch Exit in the Loop Gain Calibration pop-up menu. |
| Step 24: | Touch Cursors at the top of the screen. |
| Step 25: step. | Set Cursor 1 to the average of the bottom of the pulse before the |
| Step 26: step. | Set Cursor 2 to the average of the bottom of the pulse under the |
| Step 27: | Read ΔV , and then record this value as VL for later use. |
| Step 28: | Set Cursor 2 to the average of the top of the pulse. |
| Step 29: | Read ΔV , and then record this value as VH for later use. |
| Step 30: is ≤ 5%. | Examine that the negative dot response error [(- $V \c V H$) $	imes$ 100%] |
| Step 31: (V-VL)] is | Examine that the positive dot response error [100 % \times (VH-V)/ \leq 5%. |
| | Response at 500 mV with Automatic Calibration Settings – by eps 31 through 50. |
| Step 32: | Press the ENHANCED ACCURACY button. |
| Step 33: Loop Gai | Touch Loop Gain, and then set Divide by Two Mode to Off in the n Calibration pop-up menu. |
| Step 34: | Touch Exit. |
| Step 35: | Set the Vert Size:M1 to 100 mV/div. |
| Step 36: | Set the pulse generator's amplitude for a 500 mV step display. |
| Step 37: | Touch Cursors on the top of the screen. |
| Step 38: | Set Cursor 1 to the average of the bottom of the pulse before the |

| | Step 39: | Set Cursor 2 to the average of the top of the pulse. |
|---|-----------------------------|--|
| | Step 40: value as | Read $\Delta {f V}$ as the peak-to-peak step amplitude, and then record this ${f V}$ for later use. |
| | Step 41: | Press the ENHANCED ACCURACY button. |
| | | Touch Loop Gain and then the channel number you are using in Gain Calibration pop-up menu. |
| | Step 43: pop-up m | Set Divide by Two Mode to On in the Loop Gain Calibration senu. |
| | Step 44: | Touch Cursors at the top of the screen. |
| | Step 45: step. | Set Cursor 1 to the average of the bottom of the pulse before the |
| | Step 46: step. | Set Cursor 2 to the average of the bottom of the pulse after the |
| | Step 47: | Read the $\Delta \textbf{V}$ value, and then record this value as \textbf{VL} for later use. |
| | Step 48: | Set Cursor 2 to the average of the top of the pulse. |
| | Step 49: | Read ΔV , and then record this value as VH for later use. |
| | Step 50: is ≤ 5%. | Examine that the negative dot response error [(-VL/VH) $	imes$ 100%] |
| | Step 51: (V-VL)] is | Examine that the positive dot response error [100 % \times (VH-V)/ \leq 5%. |
| Examine Dot Response at 500 mV with default settings —by performing Steps 51 through 59. | | |
| | Step 52: | Press the ENHANCED ACCURACY button. |
| | Step 53: Calibration | Touch Loop Gain and then Recall Defaults in the Loop Gain on pop-up menu. |
| | Step 54: | Touch Exit. |
| | Step 55: | Touch Cursors at the top of the screen. |
| | Step 56: step. | Set Cursor 1 to the average of the bottom of the pulse before the |
| | Step 57: step. | Set Cursor 2 to the average of the bottom of the pulse after the |
| | Step 58: | Read the $\Delta {f V}$ value, and then record this value as ${f V}{f L}$ for later use. |
| | Step 59: Record th | Set Cursor 2 to the average of the top of the pulse and read ΔV . is value as VH . |

| | Examine that the magnitude of the negative dot response error > x 100%] is ≤20%. |
|-------------------------|---|
| eck Dot R ps 60 thro | esponse at 1V with Manual Calibration Settings – by performing ugh 70. |
| Step 61: | Press the ENHANCED ACCURACY button. |
| | Touch Loop Gain, and then set the Divide by Two Mode to Off in Gain Calibration pop-up menu. |
| Step 63: | Touch Exit. |
| | Remove the 5X attenuator, and then connect the 2X attenuator to lel you are using and the coaxial cable. |
| Step 65: | Set the Vert Size:M1 to 200 mV/div. |
| Step 66: | Set the pulse generator's amplitude for a 1 V \pm 2% step display. |
| Step 67: | Press the ENHANCED ACCURACY button. |
| • | Touch Loop Gain and then the channel number you are using in Gain Calibration pop-up menu. |
| • | Set the Divide by Two Mode to On , and then touch Manual in the Loop Gain Calibration pop-up menu. |
| Step 70: | Touch Exit. |
| of the leve | Check that the amplitude of the pulse, measured from the average $\frac{1}{2}$ under the pulse to the average of the top of the pulse, can be set $\frac{1}{2}$ nanual calibration settings to be $\frac{1}{2}$ 1V. |
| Step 72: | Repeat steps 2 through 71 for channel 2. |

Part 3 Offset

This part shows the setup and lists the procedure to examine offset and check offset change with repetition rate.

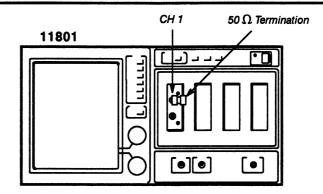
Measurement Limits

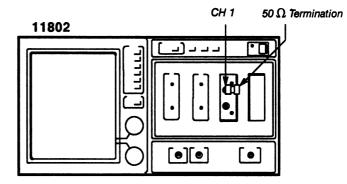
The measurement limit for the offset is ± 2 mV.

Specifications

The specification for the offset change with repetition rate is ± 5 mV.

Setup to Examine Offset



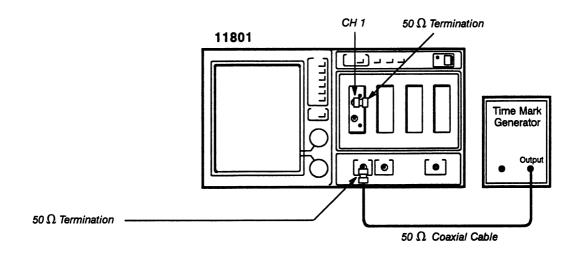


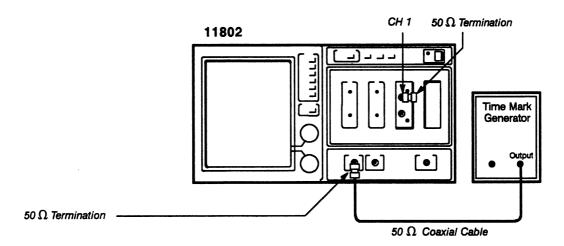
Setup to Examine Offset

Procedure to Examine Offset

| Step 2: | Touch Offset Null in the ENHANCED ACCURACY major menu. |
|-------------------|--|
| Step 3: | Touch Manual Calibrate in the Offset Nulling pop-up menu. |
| | Touch the Offset Null: M1, select 0, and then Enter in the Numeric Knob Res pop-up menu. |
| Step 5: | Touch the vertical icon, and then set Vert Size: M1 to 50 mV/div. |
| Step 6: | Press the MEASURE button. |
| Step 7: menu. | Touch Measurements and then Mean in the Measurements pop-up |
| | Touch Mean in the MEASURE major menu, and then set Data to whole zone in the Mean pop-up menu. |
| Step 9: | Examine that Mean is 0 V ±200 mV. |
| Step 10: Null. | Press the ENHANCED ACCURACY button, and then touch Offset |
| | Touch Automatic Calibrate and then Proceed in the Offset pop-up menu. |
| Step 12: | Press the MEASURE button. |
| Step 13: | Examine that the Mean (offset) is 0 ± 2 mV. |
| Step 14: | Repeat steps 2 through 13 for Channel 2. |

Setup to Check Offset Change with Repetition Rate





Setup to Check Offset Change with Repetition Rate

Procedure to Check Offset Change with Repetition Rate

| Step 2: | Press the TRIGGER button, and then touch Level. |
|-----------------------|--|
| Step 3: | Set the Trig Level until a trace appears. |
| Step 4: | Touch the vertical icon, and then set the Vert Size: M1 to 2 mV/div. |
| Step 5: screen. | Set Vert Offset: M1 so that the trace is vertically centered on the |
| Step 6: | Set the time mark generator's marker setting to 10 ms. |
| Step 7: | Press the WAVEFORM button, and then touch Acquire Desc. |
| Step 8: | Set Average N to On, and then touch Set Avg N. |
| Step 9: | Set Average N to 8 with the top knob. |
| • | Wait until the Acquire Desc selector in the WAVEFORM major ows that eight averages have been completed. |
| Step 11: | Press the MEASURE button. |
| Step 12: pop-up n | Touch Measurements and then Mean in the Measurements nenu. |
| Step 13: | Touch Compare & References in the MEASURE major menu. |
| Step 14: Compare | • |
| Step 15: | Set the time mark generator's marker setting to 5 ms. |
| Step 16: menu sho | Wait until the Acquire Desc selector in the WAVEFORM major ows that eight averages have been completed. |
| Step 17: | Check that ΔMean (offset with a repetition rate) is 0 ± 5 mV. |
| Step 18: and repe | Continue to decrease the time mark generator's marker setting, at Step 17 for each setting down to 0.1 μs . |
| Step 19: | Press the CH 2 SELECT CHANNEL button. |
| Step 20: to the Ch | • |
| Step 21: | Repeat Steps 4 through 18 for CH 2. |

Part 4 Noise

This part shows the setup and lists the procedures to check noise.

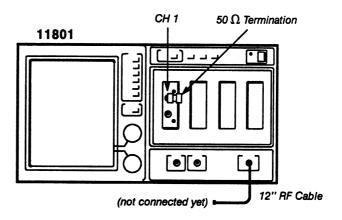
Measurement Limits (SN B020652 and above)

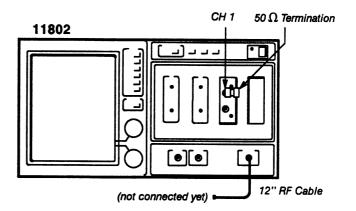
The measurement limit for noise is 1.2 mV without smoothing and 550 μV with smoothing.

Measurement Limits (SN B020651 and below)

The measurement limit for noise is 2 mV without smoothing and 900 μV with smoothing.

Setup to Examine Noise





Setup to Examine Noise

Procedure to Examine Noise

Step 1: Initialize the oscilloscope settings, then make the following settings in the order listed:

Sampling head
CH 1 SELECT CHANNEL On/Off On 11801/11802 Oscilloscope
TRIGGER button Press
Source Internal Clock
ENHANCED ACCURACY button Press

Calibrate All pop-up menu Recall Defaults

| ш | Step 2: | Touch Loop Gain in the ENHANCED ACCURACY major menu. |
|---|--|--|
| | | Disconnect the 50 Ω termination from the CH 1 input and connect BRATOR to the CH 1 input through the 12 inch RF cable. |
| | | Touch the channel number you are using, Automatic Calibrate, and ceed in the Loop Gain Calibration pop-up menu. |
| | Step 5: 50 Ω term | Disconnect the CALIBRATOR from the CH 1 input and reconnect the nination. |
| | Step 6: | Press the WAVEFORM button, and then touch Acquire Desc. |
| | Step 7: | Set Average N to On. |
| | Step 8: | Press the AUTOSET button. |
| | | Touch the vertical icon. If the Vert Size: M1 is not at 2 mV/div, then ert Size: M1 to 2 mV/div. |
| | Step 10: | Touch Def Tra at the top of the screen. |
| | Step 11: selectors | In the Vertical Description pop-up menu, touch the following in the order given: |
| | ■ Main | frame |
| | 1 | |
| | ■ - Avg (| |
| | _ | |
| | Main | frame |
| | = Maiii | frame |
| | 1) | |
| | ■ 1 ■) ■ Enter | r Desc Press the MEASURE button, and then touch Measurements. |
| | 1)EnterStep 12:Step 13: | Desc |
| | 1)EnterStep 12:Step 13:the MEAS | Press the MEASURE button, and then touch Measurements. Touch RMS in the Measurements pop-up menu, and then RMS in |
| | ■ 1 ■) ■ Enter Step 12: Step 13: the MEAS Step 14: | Press the MEASURE button, and then touch Measurements. Touch RMS in the Measurements pop-up menu, and then RMS in SURE major menu. |
| | ■ 1 ■) ■ Enter Step 12: Step 13: the MEAS Step 14: | r Desc Press the MEASURE button, and then touch Measurements. Touch RMS in the Measurements pop-up menu, and then RMS in SURE major menu. Set Data Interval to whole zone in the RMS pop-up menu. Examine that RMS is ≤1.2 mV. (SN B020652 and above) |
| | ■ 1 ■) ■ Enter Step 12: Step 13: the MEAS Step 14: Step 15: Step 16: Step 17: | Press the MEASURE button, and then touch Measurements. Touch RMS in the Measurements pop-up menu, and then RMS in BURE major menu. Set Data Interval to whole zone in the RMS pop-up menu. Examine that RMS is ≤1.2 mV. (SN B020652 and above) Examine that RMS is ≤2 mV. (SN B020651 and below) Press the WAVEFORM button. |
| | ■ 1 ■) ■ Enter Step 12: Step 13: the MEAS Step 14: Step 15: Step 16: Step 17: | Press the MEASURE button, and then touch Measurements. Touch RMS in the Measurements pop-up menu, and then RMS in SURE major menu. Set Data Interval to whole zone in the RMS pop-up menu. Examine that RMS is ≤1.2 mV. (SN B020652 and above) Examine that RMS is ≤2 mV. (SN B020651 and below) Press the WAVEFORM button. Touch Sampling Head Fnc's, and then set Smoothing to On in the |
| | ■ 1 ■) ■ Enter Step 12: Step 13: the MEAS Step 14: Step 15: Step 16: Step 17: Sampling Step 18: | Press the MEASURE button, and then touch Measurements. Touch RMS in the Measurements pop-up menu, and then RMS in SURE major menu. Set Data Interval to whole zone in the RMS pop-up menu. Examine that RMS is ≤1.2 mV. (SN B020652 and above) Examine that RMS is ≤2 mV. (SN B020651 and below) Press the WAVEFORM button. Touch Sampling Head Fnc's, and then set Smoothing to On in the Head Functions pop-up menu. |

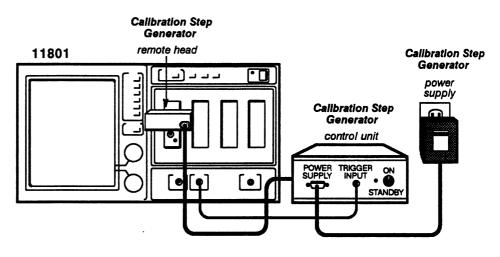
Part 5 Rise Time

This part shows the setup and lists the procedure to check the rise time.

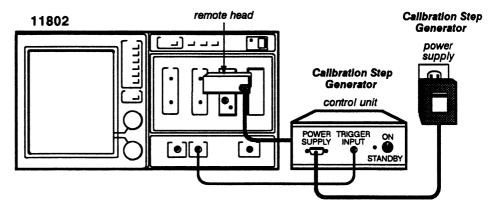
Specifications

The specification for the sampling head rise time is 17.5 ps.

Setup to Check Rise Time



Calibration Step Generator



Setup to Check Rise Time

Procedure to Check Rise Time

Step 1: Initialize the oscilloscope settings, then make the following settings in the order listed:

Sampling head

CH 1 SELECT CHANNEL On/Off On

| | 11801/11 | 802 Oscilloscope | |
|---|---|--|--|
| | | ANCED ACCURACY button press | |
| | Calibrate All pop-up menu Recall Defaults | | |
| | | GER button press | |
| | | Source Internal Clock | |
| | | on step generator STANDBY switch ON | |
| | 014/0 | on the state of th | |
| | Step 2: | Press the AUTOSET button. | |
| | Step 3: | Press the WAVEFORM button, and then touch Horizontal Desc. | |
| | Step 4: with the t | Touch Main Record Length, and then set Main Record Len to 5120 op knob. | |
| | Step 5: | Touch Acquire Desc in the WAVEFORM major menu. | |
| | Step 6: | Set Average N to On, and then touch Set Avg N. | |
| | Step 7: | Set Average N to 128 with the top knob. | |
| | Step 8: | Touch the horizontal icon, and then set the Main Size to 100 ns/div. | |
| | | Touch Main Pos and then Set to Min in the Numeric Entry & Knob- up menu. | |
| | Step 10: | Press the MEASURE button. | |
| | Step 11: menu. | Touch Measurements and then Rise in the Measurements pop-up | |
| | | Touch Rise in the MEASURE major menu, and then set Tracking to Rise pop-up menu. | |
| | Step 13: | Set the Main Size to 5 ns/div. | |
| | Step 14: | Touch Baseline in the Rise pop-up menu. | |
| | Step 15: | Touch a blank portion of the screen to exit this menu. | |
| | | Set the Baseline (bottom knob) to the average of the bottom of the ns before the step. | |
| | | Touch the horizontal icon, and then set the Main Pos so that the the left-most edge of the screen. | |
| | Step 18: | Set the Main Size to 20 ps/div. | |
| | Step 19: screen. | Set the Main Pos so that the step is approximately centered on the | |
| | Step 20: | Touch Rise in the MEASURE major menu. | |
| П | Step 21: | Record the Mean : value in the Rise pon-up menu for later use | |

| Step 22: | Calculate the sampling head rise time with the following formula: |
|----------------------|---|
| sampling rise tim | |
| Note that Ca | alibration Step Generation rise is read from the calibration step |
| | |
| Step 23: | Check that the sampling head rise time is ≤17.5 ps. |

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Part 6 Acquisition Aberrations

This part shows the setup and lists the procedures to check acquisition aberrations.

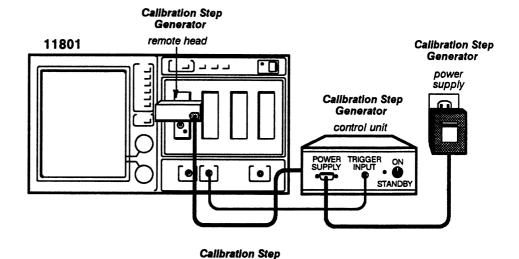
Measurement Limits

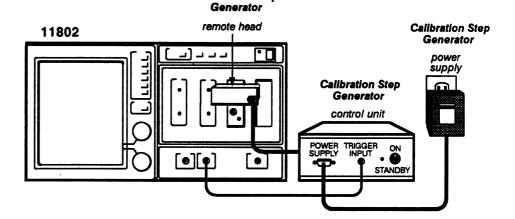
The measurement limits for acquisition aberrations are listed in Table 2-3, Aberrations Specifications.

Table 2-3 – Aberrations Specifications

| Time Difference from the Rising Edge of Waveform | Minimum Specification |
|--|----------------------------|
| 0 to 300 ps | -7% ≤ aberration % ≤12% |
| 300 ps to 5 ns | -4% ≤ aberration % ≤4% |
| 5 ns to 100 ns | -1.2% ≤ aberration % ≤1.2% |
| 100 ns and up | -0.6% ≤ aberration % ≤0.6% |
| -10 ns to -20 ps | -4% ≤ aberration % ≤4% |

Setup to Examine Acquisition Aberrations





Setup to Examine Acquisition Aberrations

Procedure to Examine Acquisition Aberrations

| Ш | Step 1: Initialize the oscilloscope settings, then make the following settings in the order listed: |
|---|---|
| | Sampling head |
| | CH1 SELECT CHANNEL On/Off On |
| | 11801/11802 Oscilloscope |
| | ENHANCED ACCURACY button press |
| | Calibrate All pop-up menu Recall Defaults |
| | TRIGGER button press |
| | Source Internal Clock |
| | Calibration step generator |
| | ON/STANDBY switch ON |
| | Step 2: Press the WAVEFORM button, and then touch Acquire Desc. |

| Step 3: | Set Average N to On, and then touch Set Avg N. |
|---------------------------------|--|
| Step 4: | Set Average N to 128 with the top knob. |
| Step 5: | Press the AUTOSET button. |
| Step 6: | Touch the horizontal icon, and then set the Main Size to 100 ns/div. |
| | Set the Main Pos so that the rising edge of the step is at the edge of the screen. |
| average (| Touch the vertical icon, and then set the Vert Offset:M1 so that the of the top of the pulse from 100 ns after the step to the right edge of in is at the horizontal centerline. |
| Step 9: | Set the Vert Size: M1 to 2 mV/div. |
| | Touch Vert Offset: M1 and then Fine in the Numeric Entry & Knob- up menu. |
| | Set Vert Offset: M1 so that the average of the top of the pulse ns after the step to the right edge of the screen is at the horizontal e. |
| aberration | Examine that the magnitude of the maximum positive and negative n occurring 100ns after the step is ≤0.75 vertical divisions from the I centerline (0.6% of the step amplitude). |
| Step 13: | Touch the horizontal icon, and then set the Main Size to 10 ns/div. |
| | Set the Main Pos so that the rising edge of the step is at the edge of the screen. |
| aberration | Examine that the magnitude of the maximum positive and negative n occurring 5 ns to 100 ns after the step is ≤1.5 vertical divisions norizontal centerline (1.2% of the step amplitude). |
| | Set the Main Size to 500 ps/div and then the Main Pos so that the ge of the step is at the left-most edge of the screen. |
| aberration | Examine that the magnitude of the maximum positive and negative n occurring 300 ps to 5 ns after the step is ≤5.0 vertical divisions norizontal centerline (4.0% of the step amplitude). |
| Step 18: | Touch the horizontal icon, and then set the Main Size to 500 ns/div. |
| Step 19: | Touch the vertical icon, and then set the Vert Size:M1 to 10 mV/div. |
| Step 20: from 100 centerline | Set the Vert Offset:M1 so that the average of the top of the pulse ns after the step to the right edge of the screen is at the horizontal e. |
| Step 21: | Touch the horizontal icon, and then set the Main Size to 50 ps. |
| Step 22: left-most | Set the Main Pos so that the rising edge of the step is at the edge of the screen. |

| Ш | occurring | Examine that the magnitude of the maximum positive aberration in the first 300 ps after the step is ≤3.0 vertical divisions from the centerline (12% of the step amplitude). |
|---|------------|--|
| | occurring | Examine that the magnitude of the maximum negative aberration in the first 300 ps after the step is ≤1.75 vertical divisions from the centerline (7% of the step amplitude). |
| | • | Touch the Main Pos selector and then Set to Min in the Numeric it Knob Res pop-up menu. |
| | Step 26: | Set the Main Size to 10 ns/div. |
| | • | Touch the vertical icon, and then set Vert Offset:M1 so that the of the bottom of the pulse 10 ns before the step is at the horizontal of the pulse 10 ns before |
| | Step 28: | Touch the horizontal icon, and then set the Main Size to 1 ns/div. |
| | • | Set the Main Pos so that the rising edge of the step is at the tedge of the screen. |
| | aberration | Examine that the magnitude of the maximum positive and negative a occurring 10 ns to 500 ps before the 10% point of the step is ical divisions from the horizontal centerline (4% of the step e) |
| | • | Set the Main Size to 50 ps/div and then the Main Pos so that the ge of the step is at the right-most edge of the screen. |
| | aberration | Examine that the magnitude of the maximum positive and negative a occurring 500 ps to 20 ps before the 10% point of the step is ical divisions from the horizontal centerline (4% of the step e) |
| | Step 33: | Repeat steps 2 through 32 for channel 2. |
| | | |

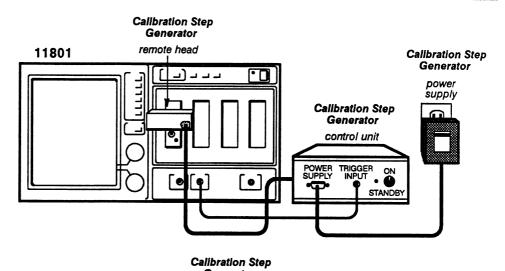
Part 7 Coincidence Between Channels

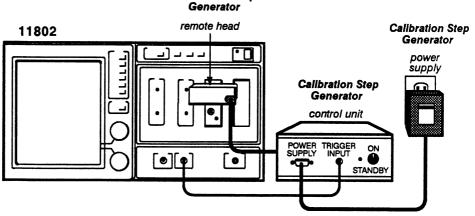
This part shows the setup and lists the procedures to check the coincidence between channels.

Specifications

The specification for the coincidence between channels is 10 ps.

Setup to Check Coincidence Between Channels





Setup to Check Coincidence Between Channels

Procedure to Check Coincidence Between Channels

| Step 1: | Initialize the oscilloscope settings, then make the following setting | s |
|-----------|---|---|
| in the or | der listed: | |
| Sampling | g head | |

CH 1 SELECT CHANNEL On/Off On

| | ENH (TRIG | 1802 Oscilloscope IANCED ACCURACY button |
|---|--------------------------------|--|
| | Calibration | on step generator STANDBY switch ON |
| | Step 2: | Press the AUTOSET button. |
| | Step 3: | Press the WAVEFORM button, and then touch Horizontal Desc. |
| | • | Touch Main Record Length , and then set Main Record Len to 1024 top knob. |
| | Step 5: | Touch Acquire Desc in the WAVEFORM major menu. |
| | Step 6: | Set Average N to On, and then touch Set Avg N. |
| | Step 7: | Set Average N to 64 with the top knob. |
| | Step 8: connect button. | Disconnect the calibration step generator remote head from CH 1, it to CH 2, and then press the CH 2 SELECT CHANNEL On/Off |
| | Step 9: | Press AUTOSET. |
| | Step 10: | Select the horizontal icon, and then set the Main Size to 10 ps/div. |
| | • | Touch Acquire Desc, and then set Average N to On in the Description pop-up menu. |
| | Step 12: | Touch Exit. |
| | Step 13: screen. | Set the Main Pos so that the step is approximately centered on the |
| | Step 14: | Press the STORE/RECALL button. |
| | Step 15: | Touch Trace 2 in the Store Trace pop-up menu. |
| | Step 16: | Touch Recall Trace in the STORE/RECALL major menu. |
| | Step 17: | Touch STO 1 in the Recall Stored Trace pop-up menu. |
| | Step 18: connect button. | Disconnect the calibration step generator remote head from CH 2, it to CH 1, and then press the CH 1 SELECT CHANNEL On/Off |
| | Step 19: | Press the MEASURE button. |
| | Step 20: pop-up r | Touch Measurements and then Prop Delay in the Measurements menu. |
| | | Touch Prop Delay in the MEASURE major menu and then Trace 3 op Delay pop-up menu. |
| П | Step 22: | Check that the magnitude of the Prop Delay is <10 ps. |

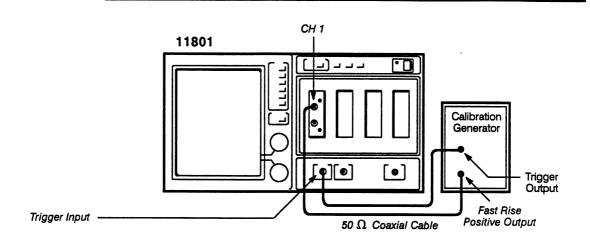
Part 8 Maximum Signal Voltage

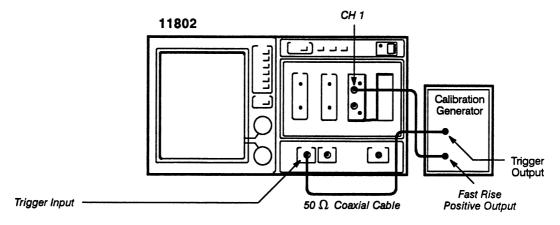
This part shows the setup and lists the procedure to examine the maximum signal voltage.

Measurement Limit

The measurement limit for the maximum signal voltage is 1% of the step amplitude.

Setup to Examine Maximum Signal Voltage





Setup to Examine Maximum Signal Voltage

2-29

| Pro | ocedure t | o Examine Maximum Signal Voltage |
|-----|---------------------|--|
| | - | nitialize the oscilloscope settings, then make the following settings der listed: |
| | 11801/11 ENH | g head 1 SELECT CHANNEL On/Off |
| | | n Size 5 μs/div on generator |
| | Amp Perio | on generator blitude maximum amplitude od 10 μs adjustment mid range |
| | - | Touch the vertical icon, and then set the Vert Offset: M1 so that the m is vertically centered on the screen. |
| | • | Set the calibration generator's amplitude so that it displays a 1 V peak square wave. |
| | Step 4: | Touch the horizontal icon, and then set the Main Size to 500 ns/div. |
| | • | Set the Main Pos so that the positive-going step is near the edge of the screen (within 1/2 division). |
| | Step 6: | Press the WAVEFORM button. |
| | Step 7: Descript | Touch Acquire Desc , and then set Average N to On in the Acquire tion pop-up menu. |
| | Step 8: | Touch Set Avg N ,and then set Average N to 128 with the top knob. |
| | • | Touch the vertical icon, and then set the Vert Offset: M1 so that the of the top of the pulse 500 ns after the step is on the horizontal e. |
| | Step 10: | Set Vert Size:M1 to 5 mV/div. |
| | • | Touch Vert Offset: M1 and then Fine in the Numeric Entry & Knot -up menu. |
| | - | Set Vert Offset: M1 so that the average of the top of the pulse 500 the step is on the horizontal centerline. |
| | Step 13: | Set the Main Size to 200 ns/div. |
| | aberratio | Examine that the magnitude of the maximum positive and negative on from 200 ns to 800 ns from the rising edge of the step is \leq 2 divisions from the horizontal centerline (1% of the step amplitude). |
| | Step 15: | Touch the horizontal icon, and then set the Main Size to 20 ns/div. |

| 8 Maximum Signal Voltage | | |
|--------------------------|---|--|
| | Step 16: Set the Main Pos so that the step is near the left-most edge of the screen (within 1/2 division) | |
| | Step 17: Examine that the magnitude of the maximum positive and negative aberration from 10 ns to 200 ns from the rising edge of the step is \leq 2 vertical divisions from the horizontal centerline (1% of the step amplitude). | |
| | Step 18: Repeat all of Part 8 for CH 2. | |
| | | |
| | | |
| | | |
| | | |
| | | |
| | | |

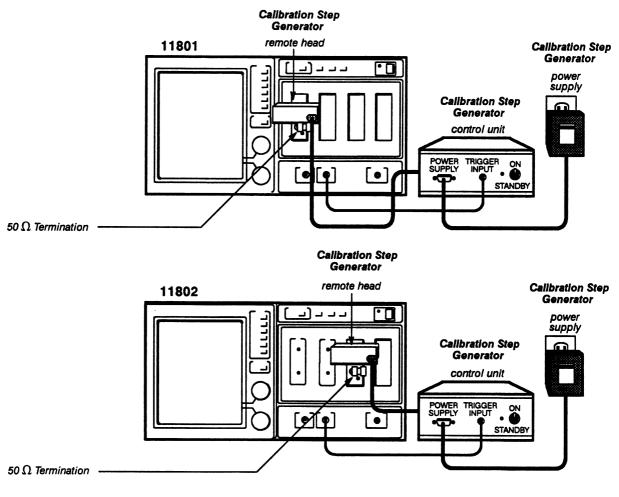
Part 9 Isolation Between Channels

This part shows the setup and lists the procedures to check the isolation between channels.

Specifications

The measurement limit for the isolation between channels is 1%.

Setup to Check Isolation Between Channels



Setup to Check Isolation Between Channels

Procedure to Check Isolation Between Channels

| ENHA C TRIG | 802 Oscilloscope ANCED ACCURACY button |
|------------------------|---|
| Calibratio | on step generator STANDBY Switch |
| Step 2: | Press the AUTOSET button. |
| Step 3: | Touch the horizontal icon, and then set the Main Size to 200 ps/div. |
| Step 4: | Press the WAVEFORM button, and then touch Horizontal Desc. |
| Step 5: with the to | Touch Main Record Length, and then set Main Record Len to 1024 op knob. |
| Step 6: | Touch Acquire Desc in the WAVEFORM major menu. |
| • | Set Average N to On, and then touch Set Avg N in the Acquire on pop-up menu. |
| Step 8: | Set Average N to 1024 with the top knob. |
| Step 9: | Press the CH 2 SELECT CHANNEL button on the sampling head. |
| Step 10: | Touch the vertical icon, and then set the Vert Size: M2 to 2 mV/div. |
| Step 11: Average | Touch Acquire Desc in the WAVEFORM major menu, and then set N to On . |
| • | Wait until the Acquire Desc selector in the WAVEFORM major ows that 1024 averages have been completed. |
| Step 13: | Touch the MEASURE button. |
| Step 14: pop-up m | Touch Measurements and then Peak-Peak in the Measurements nenu. |
| Step 15: | Record the CH 2 Peak-Peak measurement for later use. |
| Step 16: | Press the CH 1 SELECT CHANNEL button. |
| Step 17: pop-up m | Touch Measurements and then Peak-Peak in the Measurements nenu. |
| Step 18: | Record the CH 1 Peak-Peak measurement for later use. |
| Step 19: | Check that (CH 2 Peak-Peak/CH 1 Peak-Peak) $\times 100\% \le 1\%$. |
| and the 5 CH 2, cor | Disconnect the calibration step generator remote head from CH 1 0 Ω termination from CH 2. Connect the calibration step generator to nnect the 50 Ω termination to CH 1, and then press the CH 2 CHANNEL On/Off button. |
| Step 21: | Press the AUTOSET button. |
| Step 22: | Touch the horizontal icon, and then set the Main Size to 200 ps/div. |

| Step 23: | Press the CH 1 SELECT CHANNEL button. |
|----------|---|
| Step 24: | Press the AUTOSET button. |
| Step 25: | Press WAVEFORM button. |
| | Wait until the Acquire Desc selector in the WAVEFORM major ows that 1024 averages have been completed. |
| Step 27: | Press the MEASURE button. |
| Step 28: | Touch Measurements and then Peak-Peak in the Measurements nenu. |
| Step 29: | Record the CH 1 Peak-Peak measurement for later use. |
| Step 30: | Press the CH 2 SELECT CHANNEL button. |
| Step 31: | Record the CH 2 Peak-Peak measurement for later use. |
| Step 32: | Check that (CH 1 Peak-Peak/CH2 Peak-Peak) × 100% <1%. |

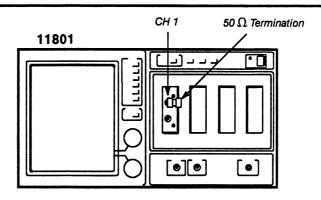
Part 10 Output Amplitude

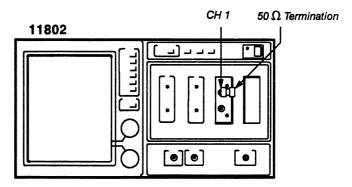
This part shows the setup and lists the procedures to check the output amplitude.

Specifications

The specification for the output amplitude is 250 mV \pm 5 mV.

Setup to Check Output Amplitude





Setup to Check Output Amplitude

Procedure to Check Output Amplitude

| Ш | • | initialize the oscilloscope settings, then make the following setting der listed: |
|----------------|---------|---|
| | Samplin | g head |
| | CH | 1 SELECT CHANNEL On/Off On |
| | 11801/1 | 1802 Oscilloscope |
| | ENH | IANCED ACCURACY button press |
| | | Calibrate All pop-up menu Recall Defaults |
| TRIGGER button | | |
| | | Source Internal Clock |
| | Step 2: | Press the WAVEFORM button, and then touch Acquire Desc . |
| | Step 3: | Set Average N to On, and then touch Set Avg N. |

| Step 4: | Set Average N to 64 with the top knob. |
|----------------------|--|
| = | Touch Sampling Head Fnc's in the WAVEFORM major menu, and the CH1 TDR to On . |
| Step 6: | Press the AUTOSET button. |
| Step 7: | Touch the horizontal icon, and then set the Main Size to 100 ns/div. |
| Step 8: | Touch Main Pos and then Min in Main Pos pop-up menu. |
| Step 9: Amplitud | Press the ENHANCED ACCURACY button, and then touch TDR le. |
| | Touch Automatic Calibrate and then Proceed in the TDR le pop-up menu. |
| Step 11: | Touch Cursors at the top of the screen. |
| Step 12: | Touch Cursor Type and then Horizontal Bars. |
| Step 13: | Touch Exit to exit this menu. |
| Step 14: | Set Cursor 1 (top knob) to the average of the base of the pulse. |
| Step 15: step. | Set Cursor 2 to the average of the top of the pulse 100 ns after the |
| Step 16: | Check that ΔV is 250 mV ± 5 mV. |
| Step 17: | Press the WAVEFORM button. |
| - | Touch Sampling Head Fnc's, and then set the TDR Polarity to - mpling Head Functions pop-up menu. |
| Step 19: | Touch Exit to exit this menu. |
| Step 20: is centered | Touch the vertical icon and set the Vert Offset: M1 so that the step ed on the screen. |
| Step 21: | Touch Cursors at the top of the screen. |
| Step 22: | Set Cursor 1 (top knob) to the average of the base of the pulse. |
| Step 23: step. | Set Cursor 2 to the average of the top of the pulse 100 ns after the |
| Step 24: | Check that ΔV is -250 mV ± 5 mV. |
| Step 25: | Repeat all of Part 10 for CH 2. |

Part 11 TDR Aberrations

This part shows the setup and lists the procedures to check the TDR aberrations.

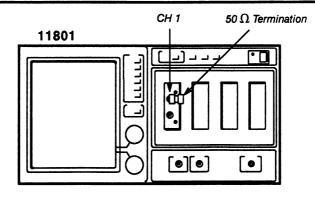
Specifications

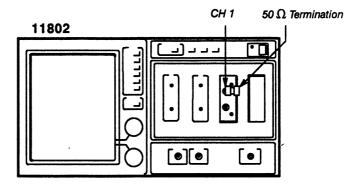
The specifications for TDR aberrations are listed in Table 2-4, Aberrations Specifications.

Table 2-4 — Aberrations Specifications

| Time Difference from the Rising Edge of Waveform | Minimum Specification | Measurement Limit |
|--|---|--|
| 0 to 300 ps | | - 5% ≤ aberration %≤15% |
| 300 ps to 5 ns | - 3% ≤ aberration %≤3% | |
| 5 ns and up | -1% ≤ aberration % ±1% | |
| -10 ns to -20 ps | -3% ≤ aberration % ≤3% | |

Setup to Check TDR Aberrations





Setup to Check TDR Aberrations

Procedure to Check TDR Aberrations

| • | Initialize the oscilloscope settings, then make the following settings der listed: |
|----------|--|
| Sampling | g head |
| CH1 | SELECT CHANNEL On/Off On |
| 11801/11 | 1802 Oscilloscope |
| ENH | ANCED ACCURACY button press |
| (| Calibrate All pop-up menu Recall Defaults |
| TRIG | GER button press |
| ; | Source Internal Clock |
| Step 2: | Press the WAVEFORM button, and then touch Acquire Desc. |
| Step 3: | Set Average N to On, and then touch Set Avg N. |
| Step 4: | Set Average N to 128 with the top knob. |
| • | Touch Sampling Head Fnc's in the WAVEFORM major menu, and the CH 1 TDR to On in the Sampling Head Functions pop-up menu. |
| Step 6: | Press the ENHANCED ACCURACY button, and then touch TDR de. |

| • | Touch Automatic Calibrate and then Proceed in the TDR de pop-up menu. |
|-----------|--|
| Step 8: | Press the AUTOSET button. |
| Step 9: | Touch the horizontal icon, and then set the Main Size to 100 ns/div. |
| • | Set the Main Pos so that the rising edge of the step is at the edge of the screen. |
| • | Touch the vertical icon, and then set the Vert Offset:M1 so that the of the top of the pulse 100 ns after the step is at the horizontal e. |
| Step 12: | Set the Vert Size: M1 to 2 mV/div. |
| • | Touch Vert Offset: M1 and then Fine in the Numeric Entry & Knob- up menu. |
| • | Set Vert Offset: M1 so that the average of the top of the pulse fter the step is at the horizontal centerline. |
| Step 15: | Touch the horizontal icon, and then set the Main Size to 10 ns/div. |
| • | Set the Main Pos so that the rising edge of the step is at the edge of the screen. |
| aberratio | Check that the magnitude of the maximum positive and negative in occurring 5 ns after the step to the right edge of the screen is ertical divisions from the horizontal centerline (1% of the step e). |
| - | Set the Main Size to 500 ps/div, and then set the Main Pos so that edge of the step is at the left-most edge of the screen. |
| aberratio | Check that the magnitude of the maximum positive and negative n occurring 300 ps to 5 ns after the step is ≤3.75 vertical divisions horizontal centerline (3% of the step amplitude). |
| Step 20: | Touch the horizontal icon, and then set the Main Size to 500 ns/div |
| Step 21: | Touch the vertical icon, and then set the Vert Size:M1 to 10 mV/div |
| • | Set the Vert Offset:M1 so that the average of the top of the pulse fter the step is at the horizontal centerline. |
| Step 23: | Touch the horizontal icon, and then set the Main Size to 50 ps/div. |
| • | Set the Main Pos so that the rising edge of the step is at the edge of the screen. |
| occurring | Examine that the magnitude of the maximum positive aberration g in the first 300 ps after the 90% point of the step is ≤3.75 vertical from the horizontal centerline (15% of the step amplitude). |

| occurring | Examine that the magnitude of the maximum negative aberration in the first 300 ps after the 90% point of the step is ≤1.25 vertical from the horizontal centerline (5% of the step amplitude). |
|----------------------|--|
| Step 27: | Set the Main Size to 2 ns/div. |
| | Touch the Main Pos selector and then Set to Min in the Numeric d Knob Res pop-up menu. |
| | Touch the vertical icon, and then set Vert Offset:M1 so that the of the bottom of the pulse 10 ns before the step is at the horizontal e. |
| Step 30: | Touch the horizontal icon, and then set the Main Size to 1 ns/div. |
| | Set the Main Pos so that the rising edge of the step is at the step of the screen. |
| aberration | Check that the magnitude of the maximum positive and negative n occurring 10 ns to 500 ps before the 10% point of the step is \leq 1.0 ivisions from the horizontal centerline (4% of the step amplitude). |
| | Set the Main Size to 50 ps/div and then the Main Pos so that the ge of the step is at the right-most edge of the screen. |
| aberration | Check that the magnitude of the maximum positive and negative n occurring 500 ps to 20 ps before the 10% point of the step is \leq 1.0 ivisions from the horizontal centerline (4% of the step amplitude) |
| Step 35: | Press the WAVEFORM button. |
| Step 36: the Samp | Touch Sampling Head Fnc's, and then set the TDR Polarity to - in pling Head Functions pop-up menu. |
| Step 37: | Repeat Steps 2 through 36. |

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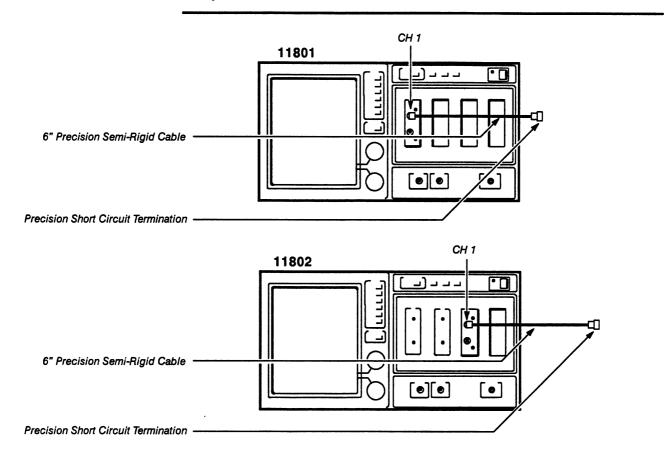
Part 12 Reflected Rise Time

This part shows the setup and lists the procedures to check the reflected rise time.

Specifications

The specification for the reflected rise time is 35 ps.

Setup to Check Reflected Rise Time



Setup to Check Reflected Rise Time

Procedure to Check Reflected Rise Time

| Step 1: Initialize the oscilloscope settings, then make the following settings in the order listed: |
|---|
| Sampling head |
| CH 1 SELECT CHANNEL On/Off On |
| 11801/11802 Oscilloscope |
| ENHANCED ACCURACY button press |
| Calibrate All pop-up menu Recall Defaults |
| TRIGGER button press |
| Source Internal Clock |

| Step 2: | Press the WAVEFORM button, and then touch Acquire Desc . |
|-----------------------------------|--|
| Step 3: | Set Average N to On, and then touch Set Avg N. |
| Step 4: | Set Average N to 128 with the top knob. |
| Step 5: then set | Touch Sampling Head Fnc's from the WAVEFORM major menu, and the CH1 TDR to On . |
| Step 6: | Press the AUTOSET button. |
| Step 7: | Touch the horizontal icon, and then set the Main Size to 5 ns/div. |
| Step 8: Entry an | Touch the Main Pos selector and then Set to Min in the Numeric d Knob Res pop-up menu. |
| Step 9: | Press the MEASURE button, and then touch Measurements. |
| | Touch Fall in the Measurements pop-up menu and then Fall in the RE major menu. |
| Step 11: menu. | Set Tracking to Off, and then touch Topline in the Fall pop-up |
| | Touch Topline in the MEASURE major menu and then Fine in the Entry & Knob Res pop-up menu. |
| Step 13: | Set the Topline (top knob) so that it is 250 mV above the Baseline. |
| | Touch the horizontal icon, and then set the Main Pos so that the step is at the left-most edge of the screen. |
| | Set the Main Size to 20 ps/div and then the Main Pos to center step on the screen. |
| Step 16: | Check that Fall (reflected rise time) is ≤35 ps. |
| Step 17: | Press the WAVEFORM button. |
| Step 18: in the Sa | Touch Sampling Head Fnc's, and then set the TDR Polarity to - mpling Head Functions pop-up menu. |
| Step 19: | Touch Exit. |
| Step 20: Fall select pulse. | Repeat Steps 6 through 16 for a negative TDR pulse. Note that all ctions must be replaced with Rise selections for a negative TDR |
| Step 21: | Repeat steps 2 through 20 for channel 2. |

Maintenance

This section contains information for performing preventive maintenance and procedures for exchanging faulty sampling heads, removing and replacing sampling head internal circuitry, and changing the sampling head identification number.

Preventive Maintenance

Preventive maintenance performed regularly can prevent or forestall the breakdown of the oscilloscope or sampling head and may improve reliability. The severity of the environment to which the sampling head is subjected determines the frequency of maintenance.

Exterior – loose dust accumulated on the outside of the oscilloscope or sampling head can be removed with a soft cloth or small brush. The brush is particularly useful for dislodging dirt in and around the sampling head connector and front-panel switches.

Periodic Electrical Checks

To ensure accurate measurements, perform periodical electrical checks on the oscilloscope and sampling head after each 2,000 hours of operation, or every 24 months if used infrequently. Procedures to perform periodic electrical checks are given in Section 2, Checks and Adjustments.

Static-Sensitive Device Classification



Static discharge can damage any semiconductor component in the oscilloscope or sampling head.

The oscilloscope and sampling head contain electrical components that are susceptible to damage from static discharge. Table 3-1 gives relative susceptibility of various classes of semiconductors. Static voltages of 1 kV to

| 30 | kv are confinor in disprotected environments. |
|----|--|
| Ob | serve the following precautions to avoid damage: |
| | Step 1: Minimize handling of static-sensitive components. |
| | Step 2: Transport and store the sampling heads in their original containers on a metal surface, or conductive foam. Transport the sampling heads with short circuit terminations on the inputs. Label any package that contains static-sensitive assemblies or components. |
| | Step 3: Discharge the static voltage from your body by wearing a wrist strap while handling these components. Servicing static-sensitive assemblies or components should be performed only at a static-free work station by qualified service personnel. We recommend the use of the static control mat and wrist strap. |
| | Step 4: Allow nothing capable of generating or holding a static charge on your work station surface. |

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| Step 5: | Keep the component leads shorted together whenever possible. |
|---------|--|
| Step 6: | Pick up components by the body, never by the leads. |
| Step 7: | Do not slide the components over any surface. |
| • | Avoid handling components in areas that have a floor or face covering capable of generating a static charge. |

Table 3-1 — Relative Susceptibility to Damage from Static Discharge

| Semiconductor Classes | Relative Susceptibility Levels ¹ |
|--|---|
| MOS or CMOS microcircuits, and discrete or linear microcircuits with MOS inputs (most sensitive) | 1 |
| ECL | 2 |
| Schottky signal diodes | 3 |
| Schottky TTL | 4 |
| High-frequency bipolar transistors | 5 |
| JFETs | 6 |
| Linear microcircuits | 7 |
| Low-power Schottky TTL | 8 |
| TTL (least sensitive) | 9 |

¹Voltage equivalent for levels.

1 = 100 to 500 V 6 = 600 to 800 V 2 = 200 to 500 V 7 = 400 to 1000 V (est.)

3 = 250 V 8 = 900 V 4 = 500 V 9 = 1200 V

5 = 400 to 600 V

(Voltage discharged from a 100 pF capacitor through a resistance of 100 Ω .)

Exchanging Sampling Heads

If a sampling head does not pass any of the parts in Section 2, Checks and Adjustments, of this manual, then it may be exchanged for a new sampling head.

Sampling head exchanges can be made with either your local Tektronix service center or with the Central Tektronix Exchange Center in Beaverton, Oregon.

For more information on exchanging your sampling head, refer to Module Exchange in Section 5, Replaceable Parts.

3-2 Maintenance

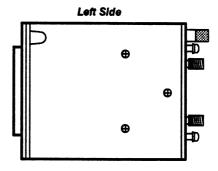
Removing and Replacing the Sampling Head Internal Circuitry

CAUTION

To avoid damage to the sampling head, set the oscilloscope ON/STANDBY switch to STANDBY and remove the sampling head from the oscilloscope before removing or replacing the internal circuitry.

Perform the following procedures to remove and replace the internal circuitry in the sampling head.

- Step 1: Remove the SELECT CHANNEL On/Off button by gently pulling on the plastic cap with a small needle-nose pliers.
- Step 2: Remove the three small Pozidrive screws on each side of the sampling head's casing (see Fig. 3-1).
- Step 3: Remove the front panel and the casing from the internal circuitry.
 - Step 4: Install the internal circuitry into the gray shipping casing.
- Step 5: Return the internal circuitry (the circuit board and attached carrier) for sampling head exchange or repair.
- Step 6: To replace the internal circuitry, follow the removal procedures in reverse order.



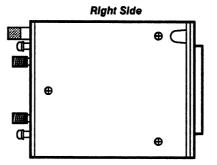


Figure 3-1 - Sampling Head Screw Locations

Changing the Sampling Head Identification Number

The following procedure allows you to change the sampling head identification number to fit the requirements of your application.

The following equipment, in addition to an 11800-Series Oscilloscope and an SD-24 TDR/Sampling Head, is necessary to perform this procedure:

- IBM PC or any other compatible PC that has MS DOS, and also has a RS-232-C serial port configured for COM1
- a serial cable

Procedure to Change the Sampling Head Identification Number:

Step 1: With the oscilloscopes PRINCIPAL POWER SWITCH set to OFF, install one of the black, plastic short-circuit jumpers across the two J860 pins on the A5 Time Base Controller Board. These short circuit jumpers are located on several jumper pins on the A5 Time Base Controller board. This board is located on the bottom of the oscilloscope, and can be accessed once the bottom panel is removed. Refer to the 11801 or 11802 Digital Sampling Oscilloscope Service Reference manual under Section 3, Maintenance for more information on accessing this board. See Figure 3-2 for the location of jumper J860.

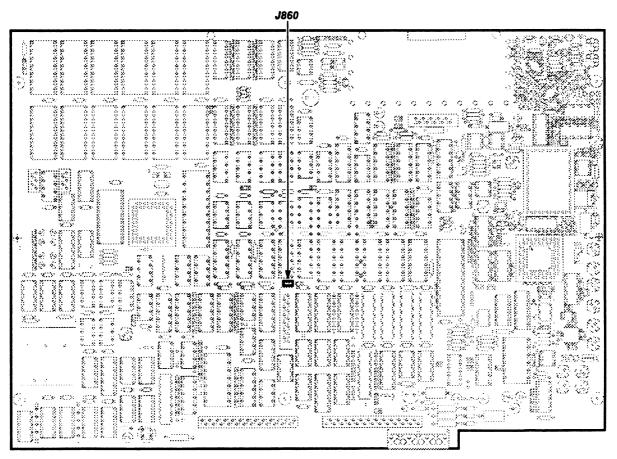


Figure 3-2 — A5 Time Base Controller Board Jumper Location

3-4 Maintenance

| Step 2: Boot up the PC with MS DOS operating. |
|--|
| Step 3: Connect the serial cable to the oscilloscope's RS-232-C port located at the rear of the oscilloscope. Connect the other end of the cable to the COM1 port on the PC. |
| Step 4: Install the SD-24 TDR/Sampling Head in any sampling head compartment in the oscilloscope. |
| Step 5: Set the PRINCIPAL POWER SWITCH to ON and the ON/STANDBY switch to ON. |
| Step 6: After the diagnostics are complete, press the UTILITY button, and then touch RS-232 Parameters. |
| Step 7: Set the Baud Rate to 4800 Bd , the Parity to none , and the Stop Bits to 1 in the RS-232 Parameters pop-up menu. |
| Step 8: On the PC, type a:, and then press the return or enter key. |
| Step 9: Insert the Sampling Head Utility Software floppy disk (provided in the front of this manual) into the "A" drive of the system controller. |
| Step 10: Type id and then press the return or enter key. |
| The PC then displays the following message: |
| Make sure 11800 RS232 port is set up as follows: |
| Baud Rate 4800 Parity none Stop bits 1 |
| Enter mainframe head number [14]" |
| Note: when entering the mainframe sampling head number, the 11802 Oscilloscope only has head number 1 and head number 2. The 11801 Oscilloscope has head number 1 through head number 4. The head numbers correspond to the sampling head compartments, and these numbers are in ascending order (reading from left to right). |
| Step 11: To Enter the sampling head number: type in the correct sampling head number, and then press the return or enter key. |
| The PC then displays the following message: |
| Current ID number is: "XXXXXXXX" Enter new ID number (8 characters max): |
| Note: the X's between the quotes represent the current ID number. Eight is the maximum number of digits allowed and one is the minimum. Any character is allowed, except a space () character. |

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| Step 12: Enter one to eight characters for the new identification number. |
|--|
| The oscilloscope will then flash the message: |
| Change in channel M $	imes$ configuration |
| four times at the top of the screen. |
| Step 13: Set the ON/STANDBY switch to STANDBY, and then switch it back to ON. |
| Step 14: To verify the new identification number, press the UTILITY button, and then touch identify . |
| The new identification number now appears under Mainframe Sampling Heads in the System Identification pop-up menu. |
| Step 15: Remove the black plastic jumper J860 that was installed in Step 1. |
| |

Theory of Operation

The SD-24 TDR/Sampling Head is a two-channel, 17.5 ps rise time sampling head. Each channel is also capable of generating its own Time Domain Reflectometry (TDR) output pulse.

When used in the acquisition mode (that is, with the TDR step generator turned off) each channel functions as a normal sampling input. Both channels are strobed simultaneously from a single strobe generator contained within the sampling head, so time coincidence between the two channels is stable. Loop gain and zeroing can be calibrated electronically by the oscilloscope with some user interaction.

In the TDR mode, a fast rise time step is generated internally for each channel and applied to the input signal path for that channel. The acquisition portion of the sampling head is still functional for monitoring the primary pulse and its reflected components. The sampling head provides two self contained TDR channels. The polarity of the output pulse can be selected independently for each channel. This allows differential or common mode testing of two coupled lines as well as independent testing of isolated lines.

System Functional Overview

This section describes and illustrates the major functional blocks of the SD-24 TDR/Sampling Head (see Fig. 4-1).

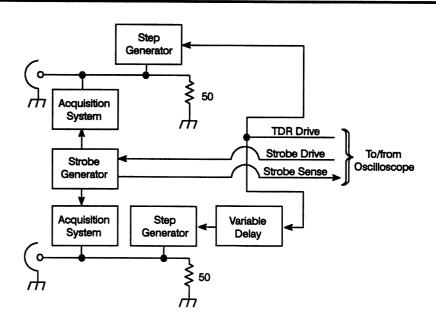


Figure 4-1 — SD-24 TDR/Sampling Head Block Diagram

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The SD-24 TDR/Sampling Head has two independent channels; each has its own acquisition and step generation circuitry. The strobe drive signal from the oscilloscope controls the timing of the strobe assertion to each acquisition system. The strobe generator in the sampling head is common to both channels, guaranteeing sampling coincidence between the two channels.

The step generators can assert a negative-going or positive-going step independently. Using both channels, you can perform differential and common mode TDR and two-port, time-domain network analysis.

The TDR drive pulse triggers the internal step generators to assert either the positive or negative transition of the TDR step signal.

The strobe sense signal is a part of the strobe signal returned to the oscilloscope. The oscilloscope monitors the time duration of the strobe drive/strobe sense loop and adjusts a delay line, inside the oscilloscope, to maintain correct strobe timing.

The acquisition rise time is 17.5 ps or less. The displayed TDR incident rise time is 28 ps or less. The combined acquisition rise time is 28 ps or less. To ensure proper timing between the two step outputs, the second channel is equipped with a variable delay.

TDR Step Generation

The step generator circuitry consists fundamentally of an adjustable current source and a diode switch. Initially, before the step, the diode switch is biased to conduct current to the output. When the diode switch opens, the step occurs. Figure 4-2 shows the switch and the current source.

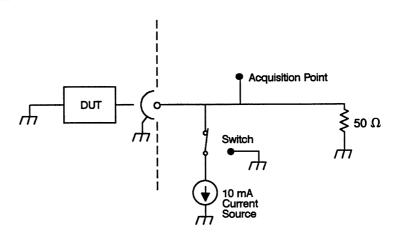


Figure 4-2 - Step Generator Simplified Schematic Diagram

Because of architecture of the step generator, the output voltage of the step depends on the DC resistance to ground of the device under test (DUT).

Operation With a Short Circuit

Initially, the diode switch is conducting –10 mA. When the step generator output is shorted, the resistance to ground is 0 Ω and the output voltage is 0 V (see 1 in Fig. 4-3).

When the diode switch opens (reverse-biased), apparent resistance to ground at the acquisition point (and at the channel connector) is 25 Ω : because the internal termination resistance is in parallel with the 50 Ω connector impedance (that is, $(50~\Omega~\times~50~\Omega)/(50~\Omega~+~50~\Omega)=25~\Omega$). The voltage at the acquisition point rises to $+250~\mathrm{mV}$ (see 2 in Fig. 4-3).

However, as soon as the transition propagates to the short in the DUT, the termination resistance is 0 Ω and the voltage level returns to 0 V. The time displayed from the first transition to the second transition is the propagation time for a signal to travel from the acquisition point to the short in the DUT and then back to the acquisition point.

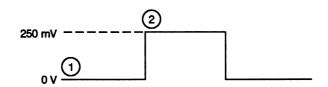


Figure 4-3 — Step Generator With a Shorted Output

Operation With a 50 Ω Load

Initially, the diode switch is conducting. When the step generator output is connected to a 50 Ω load, the resistance to ground at the acquisition point is 25 Ω : because the internal 50 Ω impedance is in parallel with the 50 Ω load (and again, $(50~\Omega~\times~50~\Omega)/(50~\Omega~+~50~\Omega)=25~\Omega)$). The 10 mA current source supplies –250 mV to the acquisition point (see 1 in Fig. 4-4).

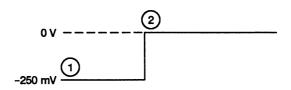


Figure 4-4 — Step Generation With a 50 Ω Load

When the diode switch opens (reverse-biased), the return path to ground is broken and the acquisition point rises to 0 V. The matched impedance allows the acquisition point to remain at 0 V (see 2 in Fig 4-4).

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Operation With an Open Circuit

Initially, the diode switch is conducting. When the step generator output is open, the resistance to ground at the acquisition point is 50 Ω : because of the internal 50 Ω impedance. The –10 mA current source supplies –500 mV to the acquisition point, as an initial condition (see 1 in Fig. 4-5).

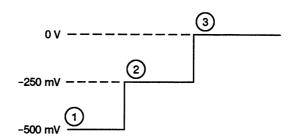


Figure 4-5 — Step Generation With a 50 Ω Load

When the diode switch opens (reverse-biased), apparent resistance to ground at the acquisition point (and at the channel connector) is 25 Ω , because the 50 Ω internal circuit impedance is in parallel with the 50 Ω connector impedance (that is, (50 Ω \times 50 Ω)/(50 Ω + 50 Ω) = 25 Ω). This causes the acquisition point to rise to -250 mV (see 2 in Fig. 4-5).

The transition propagates to the open in the DUT and is reflected back to the acquisition point, causing the voltage at the acquisition point to rise to 0 mV (see 3 in Fig. 4-5). At the acquisition point, the time displayed from the first step to the second step is the propagation time from the acquisition point to the open in the device under test and back.

TDR Amplitude

Using the SD-24 TDR/Sampling Head's internal step generator with the acquisition channel you can perform TDR measurements. You can also adjust the amplitude of the TDR step.

The TDR step amplitude setting is highly stable and insensitive to temperature variations. Usually, it is not necessary to adjust this parameter very frequently.

The SD-24 TDR/Sampling Head contains non-volatile memory that stores two values for the TDR amplitude adjustment: the factory default value and the user value.

Loop Gain

Loop gain determines the sampling head's ability to accurately follow an input voltage change that occurs between two adjacent samples. How accurately the sampling head output follows the input signal is termed as the dot transient response.

When loop gain is unity (1), the first sample value acquired after an input voltage change accurately reflects the voltage change, indicating a good dot transient response (see Fig. 4-6).

4-4 Theory of Operation

If loop gain is adjusted too low, then the value of first sample value acquired after an input voltage change will be between the value of the last sample and the new voltage.

If loop gain is adjusted too high, then the value of the first sample acquired after the input voltage change will be greater than the new voltage level.

Figure 4-6 shows the displayed trace results for the three loop gain conditions.

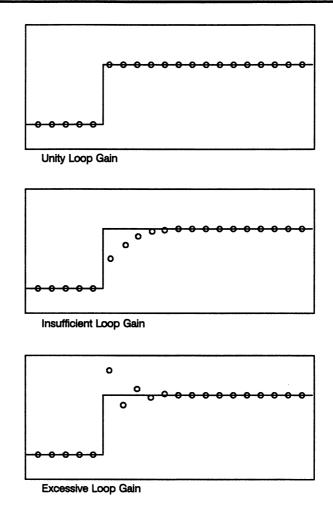


Figure 4-6 — Displayed Trace With Three Loop Gain Settings

Offset Null

The offset null adjustment removes unwanted DC offset that may be present in the sampling head. This adjustment effectively zeroes the sampling head so that an input signal with 0 V of amplitude delivers a 0 V output.

If offset null is not adjusted correctly, then measurements taken at the oscilloscope will be incorrect. The absolute voltage values for any cursors displayed on the trace will be incorrect as well.

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| | | , | |
|--|--|---|--|
| | | | |

Replaceable Parts

This section contains a list of the components that are replaceable for the SD-24 TDR/Sampling Head. As described below, use this list to identify and order replacement parts.

Parts Ordering Information

Replacement parts are available from or through your local Tektronix, Inc. Service Center or representative.

Changes to Tektronix instruments are sometimes made to accommodate improved components as they be come available and to give you the benefit of the latest circuit improvements. Therefore, when ordering parts, it is important to include the following information in your order:

- Part Numbe
- Intrument Type or Model Number
- Instrument Serial Number
- Instrument Modification Number, if applicable

If a part you order has been replaced with a different or improved part, your local Tektronix Service Center or representative will contact you concerning any change in the part number.

Change information, if any, is located at the rear of this manual.

Module Replacement

The SD-24 TDR/Sampling Head is serviced by module replacement so there are three options you should consider:

- Module Exchange. In some cases you may exchange your module for a remanufactured module. These modules cost significantly less than new modules and meet the same factory specifications. For more information about the module exchange program, call 1 800 TEKWIDE, extension BVJ5799.
- Module Repair. You may ship your module to us for repair, after which we will return it to you.
- New Modules. You may purchase new replacement modules in the same way as other replacement parts.

Using the Replaceable Parts List

The tabular information in the Replaceable Parts List is arranged for quick retrieval. Understanding the structure and features of the list will help you find the all the information you need for ordering replacement parts.

Item Names

In the Replaceable Parts List, an Item Name is separated from the description by a colon (:). Because of space limitations, an Item Name may sometimes appear as incomplete. For further Item Name identification, U.S. Federal Cataloging Handbook H6-1 can be used where possible.

Indentation System

This parts list is indented to show the relationship between items. The following example is of the indentation system used in the Description column:

2 3 4 5

Name & Description

Assembly and/or Component

Attaching parts for Assembly and/or Component

(END ATTACHING PARTS)

Detail Part of Assembly and/or Component Attaching parts for Detail Part

(END ATTACHING PARTS)

Parts of Detail Part
Attaching parts for Parts of Detail Part
(END ATTACHING PARTS)

(END ATTACHMET ATTO)

Attaching Parts always appear in the same indentation as the Item it mounts, while the detail parts are in dented to the right. Indented Items are part of, and included with, the next higher indentation. Attaching parts must be purchased separately, unless otherwise specified.

Abbreviations

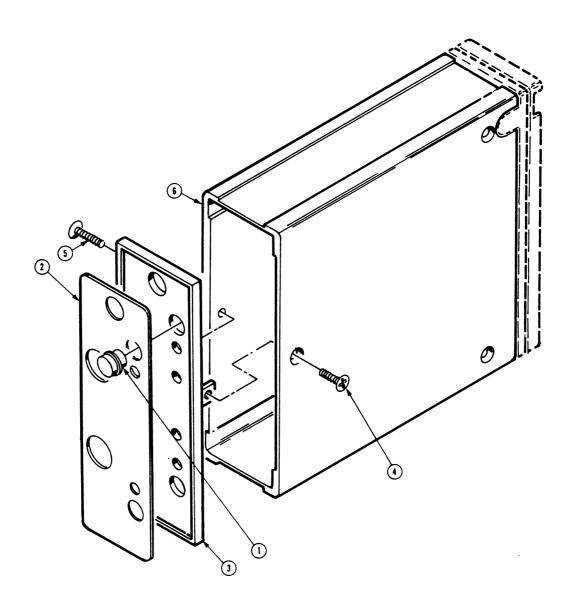
Abbreviations conform to American National Standards Institute (ANSI) standard Y1.1

CROSS INDEX - MFR. CODE NUMBER TO MANUFACTURER

| Mfr. | w 6 . | Address | City, State, Zip Code | |
|--------|------------------------------|------------------------|---------------------------|--|
| Code | Manufacturer | Aduress | City, State, Lip out | |
| 13047 | MAURY MICROWAVE CORP | 8610 HELMS AVE | CUCAMONGA CA 91730-4520 | |
| | 7.1.0.1.1 | 60 S JEFFERSON RD | WHIPPANY NJ 07981-1001 | |
| 18203 | ENGELMANN MICROWAVE DIV | OU 3 JEFFERSON RD | WITT FAIT NO 07501 1001 | |
| | DIV OF KDI ELECTRONICS INC | | | |
| 20944 | WILTRON CO | 490 JARVIS DR | MORGAN HILL CA 95037-2809 | |
| | | 14150 SW KARL BRAUN DR | BEAVERTON OR 97077-0001 | |
| 80009 | TEKTRONIX INC | | DEAVERTON OR STOTT COOL | |
| | | PO BOX 500 | | |
| 93459 | WEINSCHEL ENGINEERING CO INC | 1 WEINSCHEL LANE | GAITHERSBURG MD 20877 | |
| | | 4300 S RACINE AVE | CHICAGO IL 60609-3320 | |
| TK0435 | LEWIS SCREW CO | | | |
| TK2270 | HUBER AND SUHNER INC | 500 WEST CUMMINGS PARK | WOBURN MA 01801 | |

| Fig. & Index No. | Tektronix Part No. | Serial/Assem | | Qty | 12345 | Name & Description | Mfr. Code | Mfr. Part No. |
|------------------------|----------------------------|--------------|--------|--------|---------------------|---|--------------|-----------------------|
| | 366-0673-00 | | | | | | 80009 | |
| 1-1 -2 | | | | 2 | | .096 ID X 0.24 OD X 0.299 H | | 334-7070-00 |
| | 334-7070-00 | | | 1 | | FRONT PANEL | | 333-3427-01 |
| -3 | 333-3427-01 | | | 1 | PANEL, F | | 80009 | 333-3427-01 |
| -4 | 211 0007 01 | | | 2 | | ATTACHING PARTS) | TVAASE | ODDED BY DECCD |
| -4 -5 | 211-0087-01 | | | 3 3 | | MACHINE: 2-56 X 0.188, FLH, 82 DEG, STL | | ORDER BY DESCR |
| -5 | 211-0088-00 | | | 3 | | MACHINE: 2-56 X 0.281, FLH, 82 DEG, STL | 180433 | ORDER BY DESCR |
| -6 | 200 0021 00 | | | 1 | | IND ATTACHING PARTS) | 00000 | 380-0831-00 |
| -0 | 380-0831-00 | D010100 D | 000001 | 1 | | PLG HEAD:ALUMINUM R KIT:SD24.EXCHANGE MODULAR ASSY | | 657-0057-50 |
| | 657-0057-50 | | 020651 | 1 | | | | 657-0057-51 |
| | 657-0057-51 | DUZUOSZ | | 1 | | R ASSY:SD24,FIELD REPLACEABLE UNIT | 00009 | 657-0037-31 |
| | | | | | • | · | | |
| | | | | | 51 | ANDARD ACCESSORIES | | |
| | 015-1020-00 | | | 2 | | AXIAL:SHORT CIRCUIT,SMA | 18203 | |
| | 070-7052-00 | | | 1 | | TECH: USERS INSTALLATION, SD24 | | 070-7052-00 |
| | 070-7053-00 | | | 1 | MANUAL, | TECH:SERVICE REF,SD24 | 80009 | 070-7053-00 |
| | | | | | OP | TIONAL ACCESSORIES | | |
| | 011-0148-00 | | | 1 | TERM,CO | AX:50+/-0.1 OHM, PRECISION 3.5MM, MALE | 80009 | 011-0148-00 |
| | 011-0149-00 | | | 1 | TERM, CO | AX:50 OHM,26.5 GHZ,PRECISION 3.5MM,F | 20944 | 28KF50 |
| | 011 0150 00 | | | | | ONNECTOR | 40047 | 0000 |
| | 011-0150-00 | | | 1 | | AX:SHORTING,40GHZ,APC,3.5MM | 13047 | |
| | 011-0151-00 | | | 1 | | AX:SHORTING,40GHZ,APC,3.5MM | 13047 | |
| | 011-0152-00 | | | 1 | | OAX:50 OHM,6DB,26.5GHZ | 20944 | 41KB-20 |
| | 011-0153-00 | | | 1 | | OAX:50 OHM,20DB,26.5GHZ LEC:MALE TO FEMALE,SMA | | MODEL 1588 |
| | 015-0549-00 015-0550-00 | | | 1 1 | | PC,ELEC:3.5MM,FEMALE TO FEMALE | 13047 | |
| | 015-0551-00 | | | 1 | | PC, ELEC: 3.5MM, MALE TO MALE | 13047 | |
| | 015-0552-00 | | | 1 | | PC, ELEC: 3.5MM, MALE TO FEMALE | 13047 | |
| | 015-0553-00 | | | i | | MA, ELEC: MALE TO FEMALE, SLIDE ON MALE | | 015-0553-00 |
| | 015-0557-00 | | | i | | IVIDER:DC-26.5 GHZ,APC 3.5 | 20944 | |
| | 015-0558-00 | | | ī | | TOR, ELEC: 10 X 20DB, DC TO 10 GHZ | | 015-0558-00 |
| | 015-0561-00 | | | ī | | COAX:50 OHM,4NS,W/CONN,SMA,MALE,EACH | | 015-0561-00 |
| | | | | _ | END | ,,,,,, | | |
| | 015-0562-00 | | | 1 | CA DLY, | COAX:50 OHM,1NS,W/CONN,SMA,MALE,EACH | TK2270 | 4114-23091010 |
| | 015-0563-00 | | | 1 | | COAX:50 OHM,2NS,W/CONN,APC 3.5MM,COM | TK2270 | 4114-23182828 |
| | | | | | | ,MALE ,EACH END | | |
| | 015-0564-00 | | | 1 | | COAX:50 OHM,500PS,W/CONN,APC 3.5MM,C | 20944 | K120-6 |
| | | | | | | LE,MALE,EACH END,0.085 SEMI RIGID | | |
| | 020-1693-00 | | | 1 | COMPONE | | | 020-1693-00 |
| | 067-1338-00 | | | 1 | FIXTURE | ,CAL:11801,SAMPLING HEAD CAL UNIT | 80009 | 067-1338-00 |
| | 007 1000 01 | | | | (STANDAI | | 00000 | 007 1000 01 |
| | 067-1338-01 | | | 1 | | ,CAL:11801,SAMPLING HEAD CAL | 80009 | 067-1338-01 |
| | 067-1338-02 | | | 1 | (EUROPE/ FIXTURE | AN) ,CAL:11801,SAMPLING HEAD CAL | 80009 | 067-1338-02 |
| | | | | | | KINGDOM) | | |
| | 067-1338-03 | | | 1 | | ,CAL:11801,SAMPLING HEAD CAL | 80009 | 067-1338-03 |
| | | | | | (AUSTRAI | | | |
| | 067-1338-05 | | | 1 | | CAL:11801,SAMPLING HEAD CAL | 80009 | 067-1338-05 |
| | 067-1338-06 | | | 1 | (SWISS) | .CAL:SAMPLING HEAD CAL UNIT.JAPANESE | 80009 | 067-1338-06 |
| | 00/-1330-00 | | | 1 | (JAPANES | | 00003 | 00/ -1330 - 00 |

| | , | | |
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MANUAL CHANGE INFORMATION

At Tektronix, we continually strive to keep up with latest electronic developments by adding circuit and component improvements to our instruments as soon as they are developed and tested.

Sometimes, due to printing and shipping requirements, we can't get these changes immediately into printed manuals. Hence, your manual may contain new change information on following pages.

A single change may affect several sections. Since the change information sheets are carried in the manual until all changes are permanently entered, some duplication may occur. If no such change pages appear following this page, your manual is correct as printed.

SEND TO: TEKTRONIX, INC.

LAB INSTRUMENTS MARKETING SUPPORT

P.O. BOX 500, DEL STA 39-327 BEAVERTON, OREGON 97077

11000-SERIES OSCILLOSCOPE PROBLEM REPORT

A INSTRUMENT CONFIGURATION:

| Option Information | | | | | | |
|------------------------|-------------------------|------------------------------|-----------------------------|-----------------------------|---|--|
| | | | | | | |
| | | | | | | |
| COMPANY NAME | | | | | | |
| COMPANY NAME: | | | | REASON FOR REPORT | | |
| ADDRESS: | ER: | | | | | |
| CITY: | STATE: | | ☐ Software/Firmware Problem | | | |
| PHONE: | | STATE: ZIP: EXTENSION: | | | □ Documentation Problem□ Suggested Enhancement | |
| | | | | | | |
| SUBMITTED BY: | | D.A.T.D. | | IS THE PROBLEM REPRODUCIBLE | | |
| JODINITIED BI. | | DATE: | | ☐ Yes ☐ No [| ☐ Intermitte | |
| SYSTEM DESCRIPTION: (H | ardware, software, firi | mware and host related to th | ne problem) | | | |
| | | | | | | |
| | | | | | | |
| DESCRIPTION OF PROBLEM | 1 : | | | | | |
| | | | | | | |
| | | | | | | |
| | | | | | | |
| | | | | | | |
| | | | | | | |

LIST ENCLOSURES:



Instructions For Completing The Problem Report

I. Please type or print clearly. Use a separate Problem Report (PR) for each problem.

II. SECTION A

Fill in the instrument configuration table, including all plug-in units, modules, and probes installed in the oscilloscope. The information can be found in one of the menus under the UTILITY major menu.

Instrument: Write the instrument name (e.g., 11301, 11401, 11A32, etc.).

Section (Microprocessor Subsystem): If the instrument has more than one section write the section name. For plug-ins, write in which mainframe slot they are located (e.g., left, center, right).

ROM (Version): Write the rom version number for each instrument and section. Instruments with more than one section will have more than one version number.

ID# (Serial Number): Write the serial number for each instrument. At the factory the ID number is programmed to be the instrument's serial number. If this value has been changed, please write the serial number physically attached to the instrument (mainframes: front panel, plug-in units: top rail).

III. SECTION B

Use the complete company mailing address. Include the name and phone number of the person reporting the error. Also, be sure to fill in the name of the person submitting the PR.

IV. SECTION C

Check the reason for the report and whether the problem is reproducible. We cannot fix a problem when we cannot reproduce the problem condition.

V. SECTION D

Give a complete description of the system configuration on which the problem occurred. Include related peripherals, interfaces, options, special switch and/or strap settings and operating system.

VI. SECTION E

Describe the problem completely. Include any information which might help in evaluating the error with the PR. If you have determined a procedure to avoid the error condition, please include this procedure. If this problem prevents you from accomplishing any useful work with the product, please state this fact. Be sure to include with the PR any information (programs, listings, hard copies, etc.) which will help us duplicate your problem.

VII. SECTION F

This section is for use by Tektronix Lab Instruments Marketing Support personnel. DO NOT WRITE IN THIS SPACE.

VIII. Mail all copies of the Problem Report to:

TEKTRONIX, INC. LAB INSTRUMENTS MARKETING SUPPORT P.O. BOX 500, DEL STA 39-327 BEAVERTON, OREGON 97077

| | INTERNAL USE ONLY (DO NOT WRITE BELOW THIS LINE) | |
|---|--|---------------|
| , | | DATE RECEIVED |
| | | IR # |